

2SJ319(L), 2SJ319(S)

Silicon P Channel MOS FET

REJ03G0858-0200
(Previous: ADE-208-1192)

Rev.2.00

Sep 07, 2005

Description

High speed power switching

Features

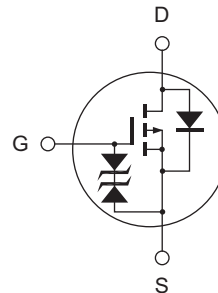
- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator, DC-DC converter

Outline

RENESAS Package code: PRSS0004ZD-A
(Package name: DPAK (L)-(1))



RENESAS Package code: PRSS0004ZD-C
(Package name: DPAK (S))



1. Gate
2. Drain
3. Source
4. Drain

Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Drain to source voltage	V_{DS}	-200	V
Gate to source voltage	V_{GS}	±20	V
Drain current	I_D	-3	A
Drain peak current	$I_{D(pulse)}$ ^{Note 1}	-12	A
Body to drain diode reverse drain current	I_{DR}	-3	A
Channel dissipation	P_{ch} ^{Note 2}	20	W
Channel temperature	T_{ch}	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

Notes: 1. $PW \leq 10 \mu s$, duty cycle $\leq 1\%$ 2. Value at $T_c = 25^\circ C$

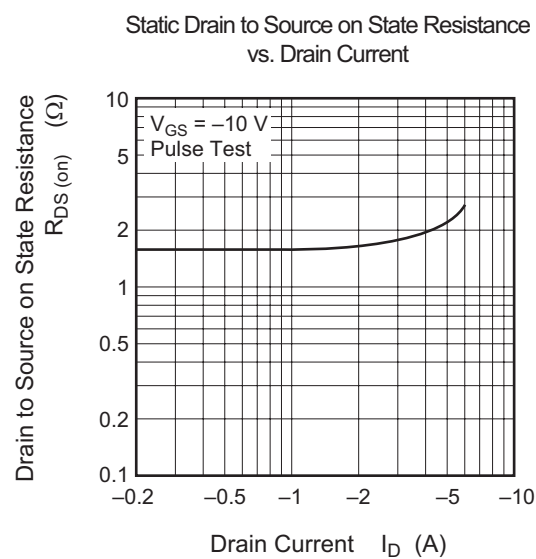
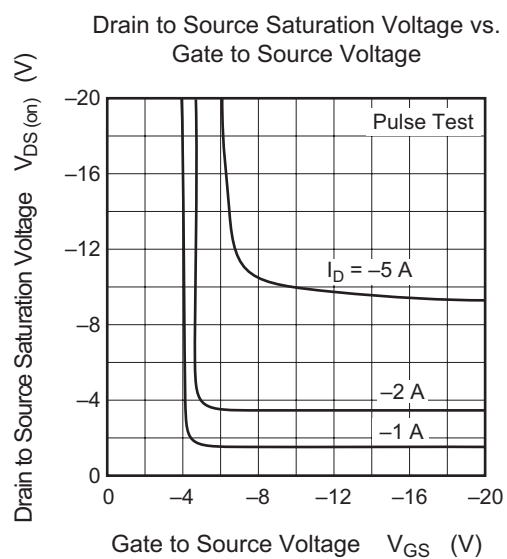
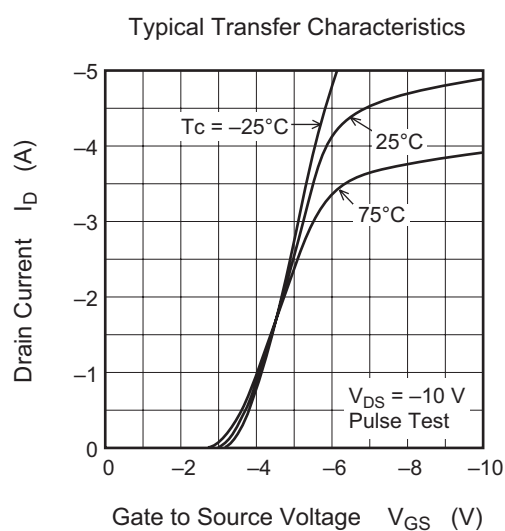
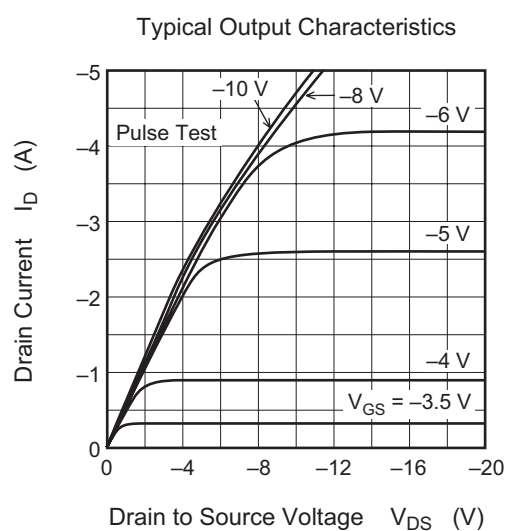
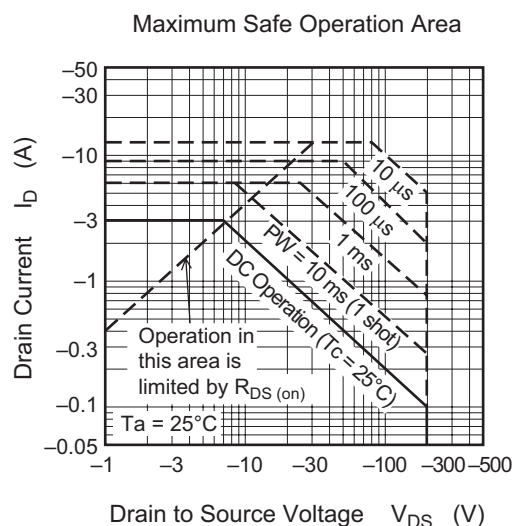
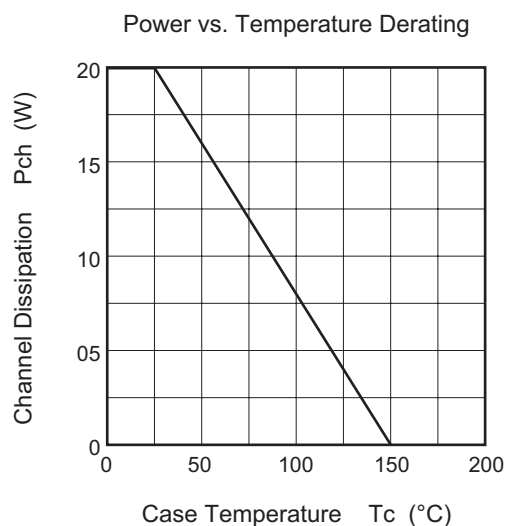
Electrical Characteristics

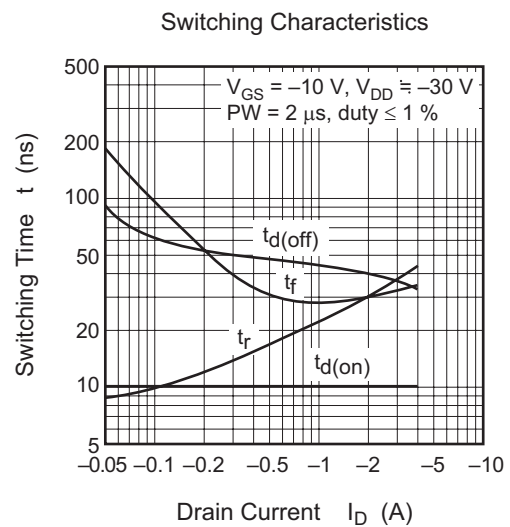
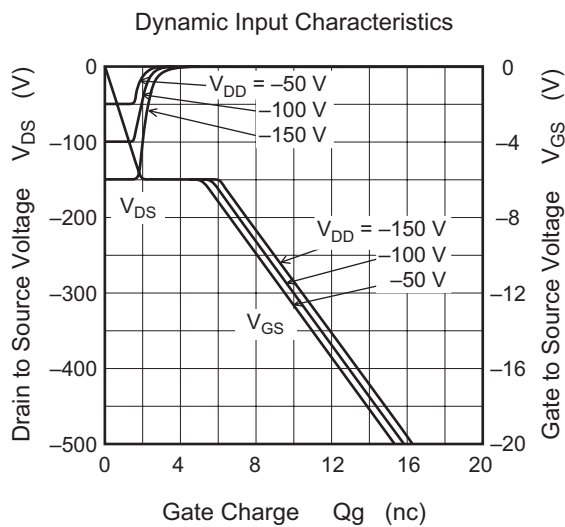
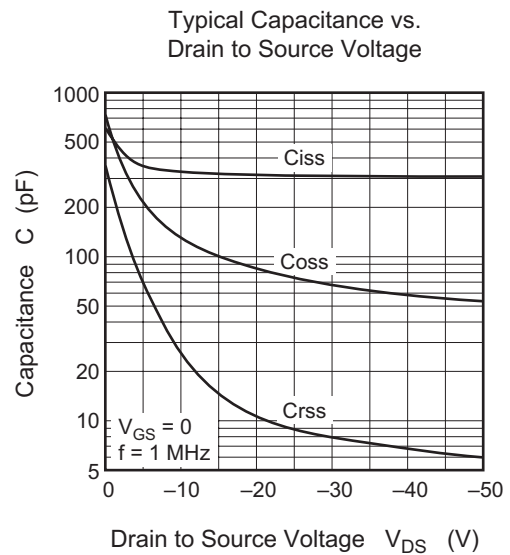
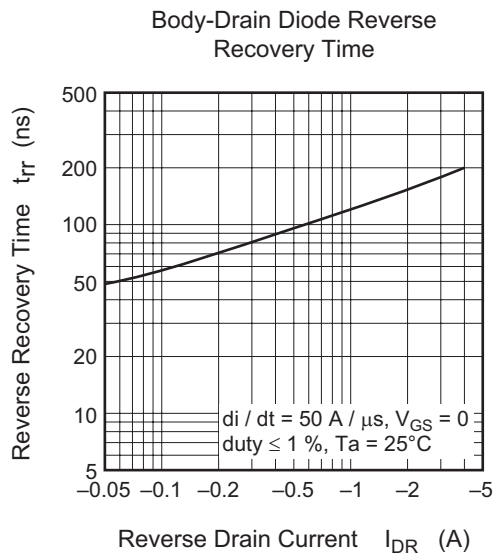
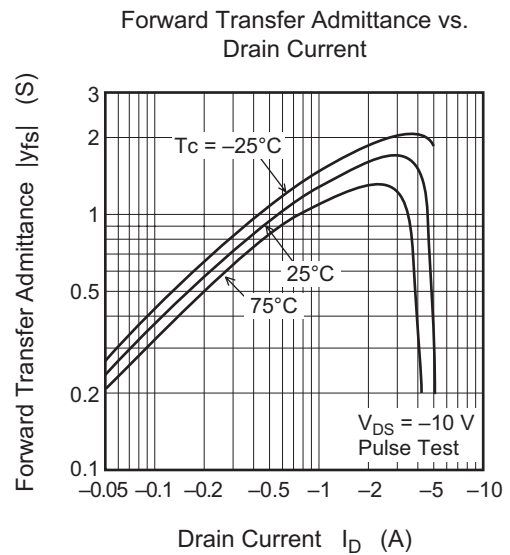
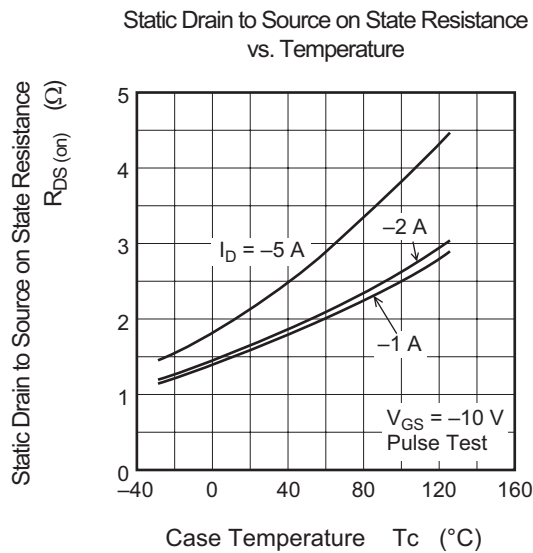
(Ta = 25°C)

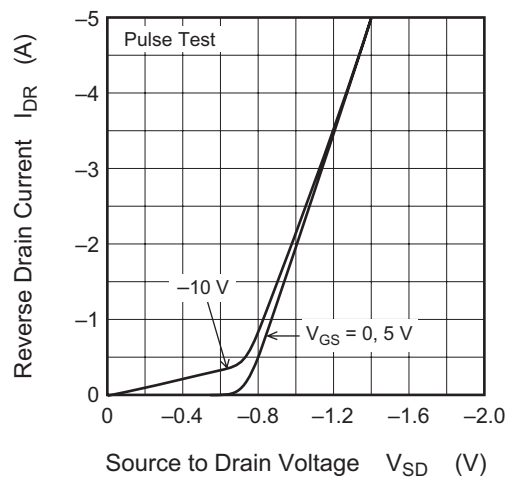
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DS}$	-200	—	—	V	$I_D = -10 \text{ mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GS}$	±20	—	—	V	$I_G = \pm 100 \mu A$, $V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	±10	μA	$V_{GS} = \pm 16 \text{ V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	-100	μA	$V_{DS} = -160 \text{ V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	-2.0	—	-4.0	V	$I_D = -1 \text{ mA}$, $V_{DS} = -10 \text{ V}$
Static drain to source on state resistance	$R_{DS(on)}$	—	1.7	2.3	Ω	$I_D = -2 \text{ A}$, $V_{GS} = -10 \text{ V}$ ^{Note 3}
Forward transfer admittance	$ y_{fs} $	1.0	1.7	—	S	$I_D = -2 \text{ A}$, $V_{DS} = -10 \text{ V}$ ^{Note 3}
Input capacitance	C_{iss}	—	330	—	pF	$V_{DS} = -10 \text{ V}$ $V_{GS} = 0$ $f = 1 \text{ MHz}$
Output capacitance	C_{oss}	—	130	—	pF	
Reverse transfer capacitance	C_{rss}	—	25	—	pF	
Turn-on delay time	$t_{d(on)}$	—	10	—	ns	$I_D = -2 \text{ A}$ $V_{GS} = -10 \text{ V}$ $R_L = 15 \Omega$
Rise time	t_r	—	30	—	ns	
Turn-off delay time	$t_{d(off)}$	—	40	—	ns	
Fall time	t_f	—	30	—	ns	
Body to drain diode forward voltage	V_{DF}	—	-1.15	—	V	$I_F = -3 \text{ A}$, $V_{GS} = 0$
Body to drain diode reverse recovery time	t_{rr}	—	180	—	ns	$I_F = -3 \text{ A}$, $V_{GS} = 0$ $di_F/dt = 50 \text{ A}/\mu s$

Note: 3. Pulse test

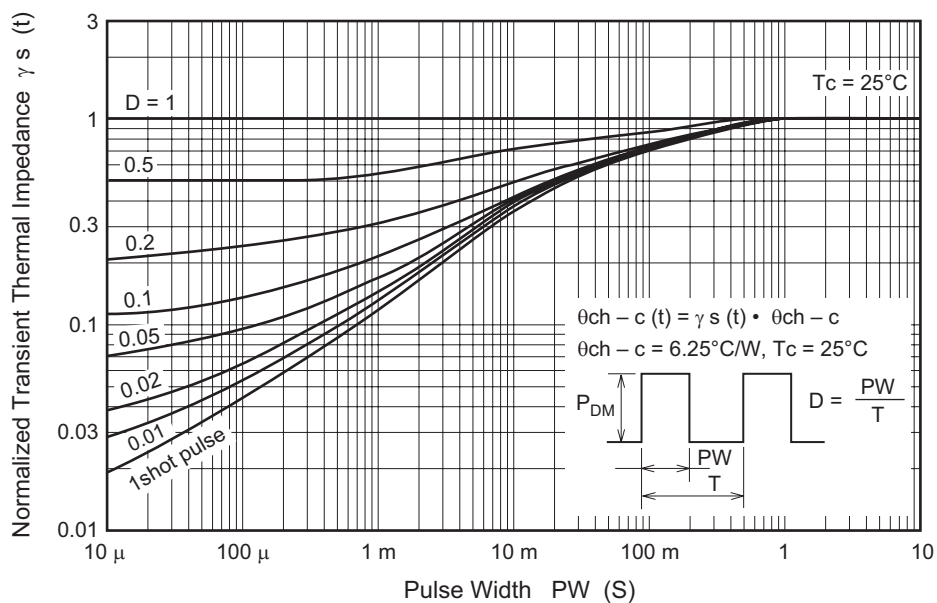
Main Characteristics



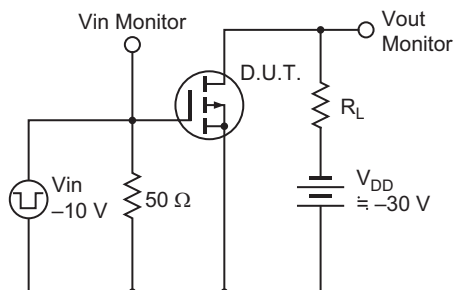


Reverse Drain Current vs.
Source to Drain Voltage

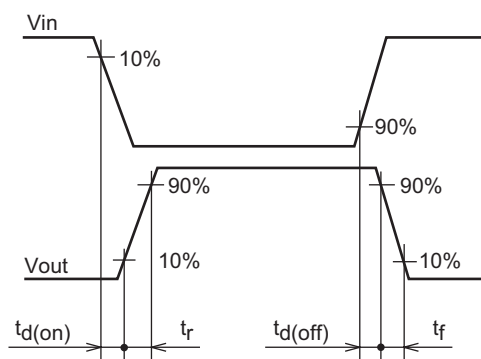
Normalized Transient Thermal Impedance vs. Pulse Width



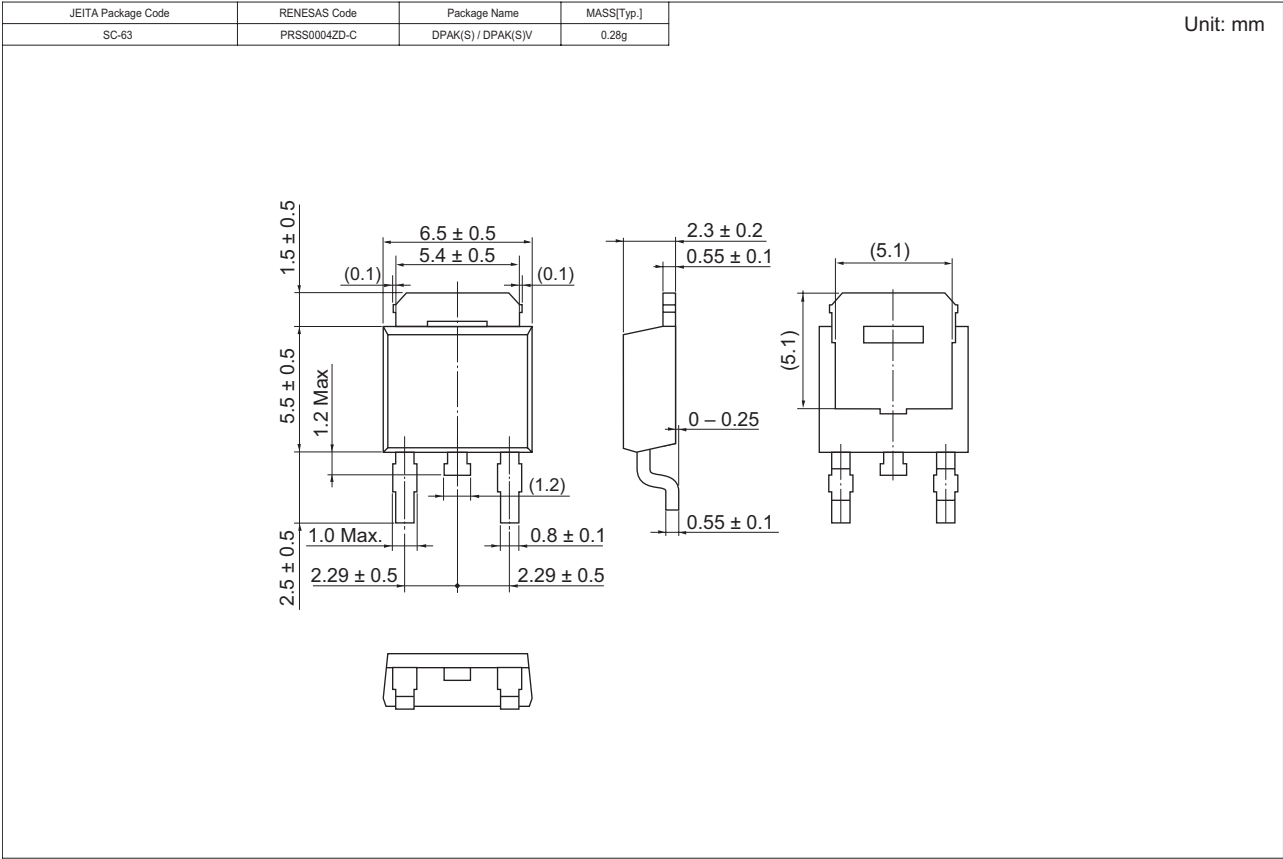
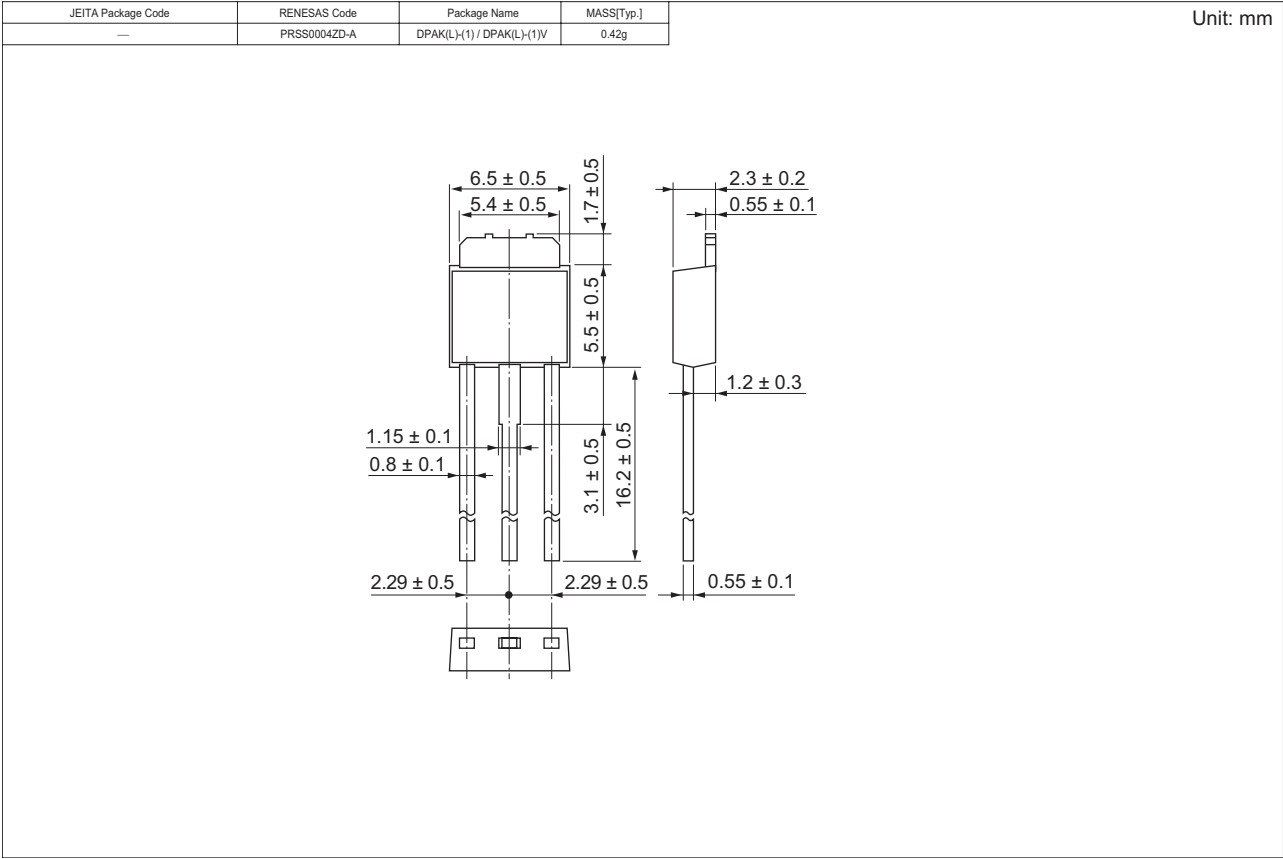
Switching Time Test Circuit



Waveform



Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SJ319L-E	3200 pcs	Box (Sack)
2SJ319STL-E	3000 pcs	Taping

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Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

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Tel: <852> 2265-6688, Fax: <852> 2730-6071

Renesas Technology Taiwan Co., Ltd.

10th Floor, No.99, Fushing North Road, Taipei, Taiwan
Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology (Shanghai) Co., Ltd.

Unit2607 Ruijing Building, No.205 Maoming Road (S), Shanghai 200020, China
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Renesas Technology Singapore Pte. Ltd.

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Tel: <82> 2-796-3115, Fax: <82> 2-796-2145

Renesas Technology Malaysia Sdn. Bhd.

Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia
Tel: <603> 7955-9390, Fax: <603> 7955-9510